

INTERNATIONAL  
GEMOLOGICAL  
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

March 11, 2025

IGI Report Number

LG685551451

Description

LABORATORY GROWN DIAMOND

Shape and Cutting Style

CUT CORNERED RECTANGULAR MODIFIED BRILLIANT

Measurements

6.46 X 5.09 X 3.44 MM

GRADING RESULTS

Carat Weight

1.04 CARAT

Color Grade

E

Clarity Grade

VS 1

ADDITIONAL GRADING INFORMATION

Polish

EXCELLENT


Symmetry

EXCELLENT

Fluorescence

NONE

Inscription(s)

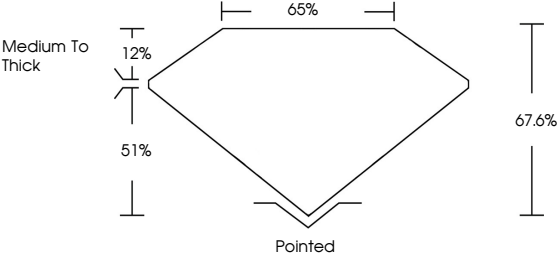
 LG685551451


Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.  
Type II

LG685551451

Report verification at [igi.org](http://igi.org)

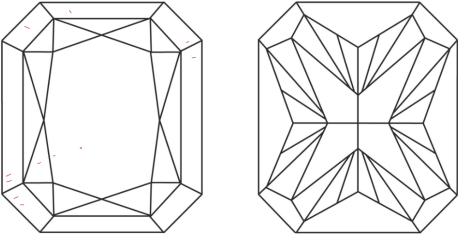
PROPORTIONS





Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.  
Green symbols indicate external characteristics.

COLOR


D E F G H I J Faint Very Light Light

CLARITY

IF VS <sup>1-2</sup> VS <sup>1-2</sup> SI <sup>1-2</sup> I <sup>1-3</sup>

Internally Flawless Very Very Slightly Included Very Slightly Included Slightly Included Included

LABORATORY GROWN DIAMOND REPORT



IGI

March 11, 2025

IGI Report No LG685551451

CUT CORNERED RECT. MODIFIED BRILLIANT

6.46 X 5.09 X 3.44 MM

Carat Weight

1.04 CARAT

Color Grade

E

Clarity Grade

VS 1

Depth

67.6%

Table

65%

Girdle

Medium To Thick

Culet

Pointed

Polish

EXCELLENT


Symmetry

EXCELLENT

Fluorescence

NONE


Inscription(s)

 LG685551451

Comments: As Grown - No indication of post-growth treatment.  
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Type II

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